

## Electronic Patent Application Fee Transmittal

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|---|---|
| <b>Application Number:</b>                  | 10594907  |
| <b>Filing Date:</b>                         | 07-Aug-2008   |
| <b>Title of Invention:</b>                  | LASER PROCESSING METHOD FOR CUTTING SUBSTRATE AND LAMINATE PART BONDED TO THE SUBSTRATE |
| <b>First Named Inventor/Applicant Name:</b> | Takeshi Sakamoto  |
| <b>Filer:</b>                               | Nikolaus P. Schibli/Margit Phillips   |
| <b>Attorney Docket Number:</b>              | 46884-5519 (232060)   |

Filed as Large Entity

### U.S. National Stage under 35 USC 371 Filing Fees

| Description                              | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|--|----------|----------|--------|----------------------|
| <b>Basic Filing:</b>                     |          |          |        |                      |
| <b>Pages:</b>                            |          |          |        |                      |
| <b>Claims:</b>                           |          |          |        |                      |
| <b>Miscellaneous-Filing:</b>             |          |          |        |                      |
| <b>Petition:</b>                         |          |          |        |                      |
| <b>Patent-Appeals-and-Interference:</b>  |          |          |        |                      |
| <b>Post-Allowance-and-Post-Issuance:</b> |          |          |        |                      |
| <b>Extension-of-Time:</b>                |          |          |        |                      |
| Extension - 2 months with \$0 paid       | 1252     | 1        | 560    | 560                  |

| Description       | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-------------------|----------|----------|--------|----------------------|
| Miscellaneous:    |          |          |        |                      |
| Total in USD (\$) |          |          |        | 560                  |